

JUNCTION FIELD EFFECT TRANSISTOR

2SK238

FM TUNER

N-CHANNEL SILICON JUNCTION FIELD EFFECT TRANSISTOR

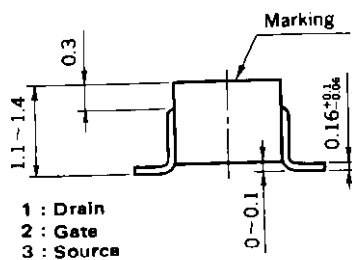
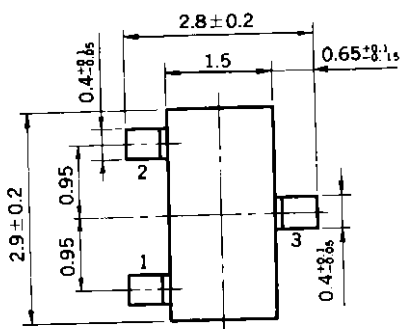
MINI MOLD

FEATURES

- Low Feedback Capacitance $C_{rss} = 0.07$ pF TYP.
- High $|y_{fs}|$ $|y_{fs}| = 3.5$ ms TYP.

PACKAGE DIMENSIONS

in millimeters



ABSOLUTE MAXIMUM RATINGS

Maximum Voltages and Currents ($T_a = 25^\circ\text{C}$)

Gate to Drain Voltage	V_{GDO}	-20	V
Drain to Source Voltage ($V_{GS} = -2.5$ V)	V_{DSX}	20	V
Drain Current (DC)	I_D	10	mA
Gate Current (DC)	I_G	10	mA

Maximum Power Dissipation

Total Power Dissipation at 25°C Ambient Temperature	P_T	150	mW
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Maximum Temperatures

Junction Temperature	T_j	125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55 to +125	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Gate Cutoff Current	I_{GSS}			-100	nA	$V_{GS} = -0.5$ V, $V_{DS} = 0$
Zero-Gate Voltage Drain Current	I_{DSS}	0.5	2.5	8.0	mA	$V_{DS} = 5.0$ V, $V_{GS} = 0$
Gate to Source Cutoff Voltage	$V_{GS(off)}$			-2.5	V	$V_{DS} = 5.0$ V, $I_D = 10$ μA
Forward Transfer Admittance	$ y_{fs} _1$	2.3	3.5		mS	$V_{DS} = 5.0$ V, $I_D = 0.5$ mA, $f = 1.0$ kHz
Forward Transfer Admittance	$ y_{fs} _2$	2.3			mS	$V_{DS} = 5.0$ V, $V_{GS} = 0$, $f = 1.0$ kHz
Input Capacitance	C_{iss}		5.0	6.5	pF	$V_{DS} = 5.0$ V, $V_{GS} = 0$, $f = 1.0$ MHz
Feedback Capacitance	C_{rss}		0.07	0.25	pF	$V_{DS} = 5.0$ V, $V_{GS} = 0$, $f = 1.0$ MHz
Output Capacitance	C_{oss}		4.5	6.0	pF	$V_{DS} = 5.0$ V, $V_{GS} = 0$, $f = 1.0$ MHz
Power Gain	G_{PS}		21		dB	$V_{DS} = 5.0$ V, $V_{GS} = 0$, Z_{in} , $Z_{out} = 50$ Ω $f = 100$ MHz See Test Circuits
Noise Figure	NF		3.0		dB	

I_{DSS} Classification

MARK	K14	K15	K16	K17
I_{DSS} (mA)	0.5 to 1.5	1.0 to 3.0	2.0 to 6.0	4.0 to 8.0

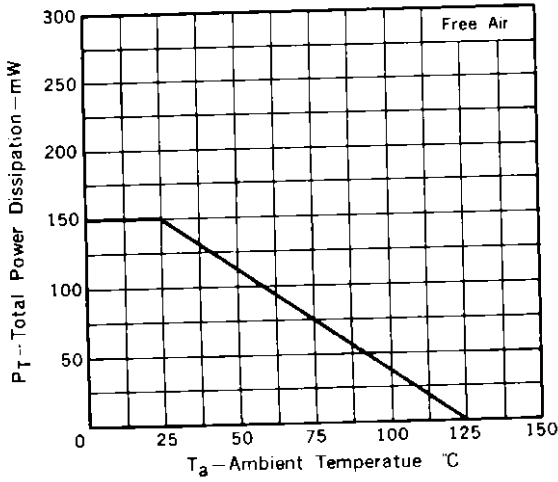
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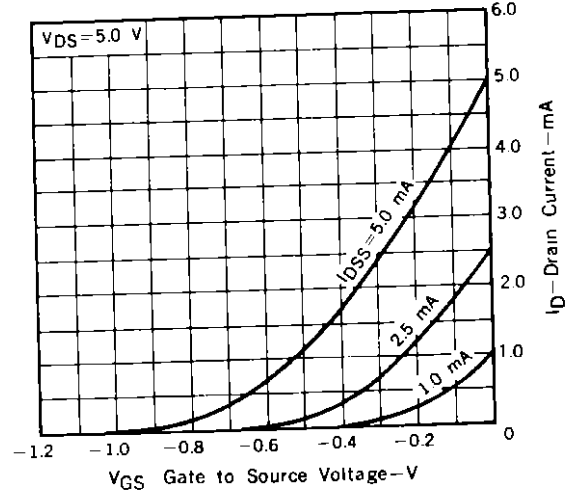
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TYPICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

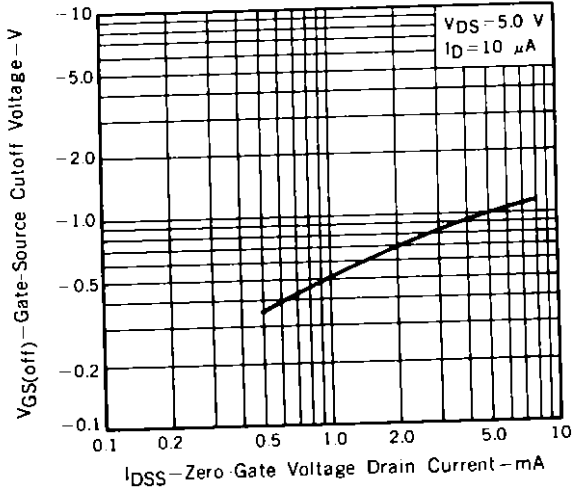
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



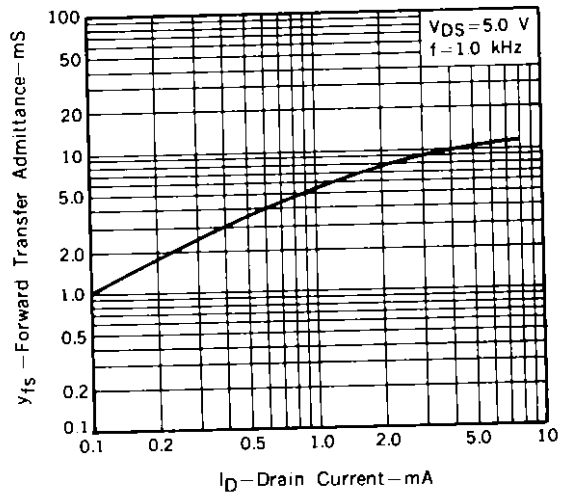
DRAIN CURRENT vs. GATE TO SOURCE VOLTAGE



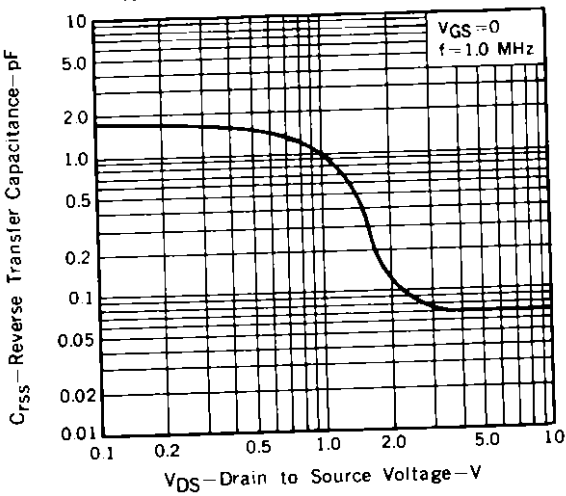
GATE-SOURCE OUTPUT VOLTAGES vs. ZERO-GATE VOLTAGE DRAIN CURRENT CORRELATION



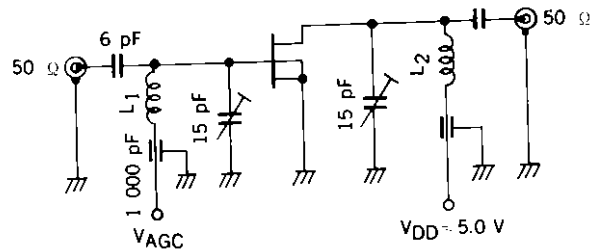
FORWARD TRANSFER ADMITTANCE (y_{fs}) vs. DRAIN CURRENT

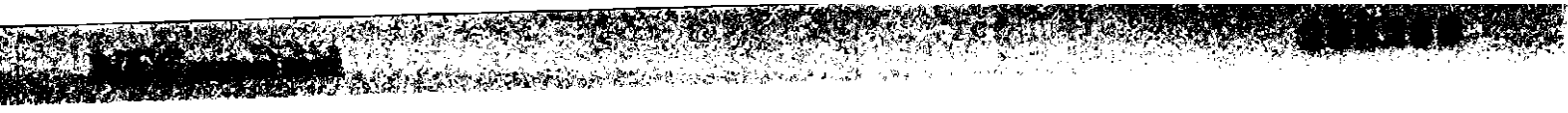


REVERSE TRANSFER CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



NOISE FIGURE AND POWER GAIN TEST CIRCUIT ($f=100\text{ MHz}$)





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